N-Channel Enhancement Mode Power MOSFET

DESCRIPTION

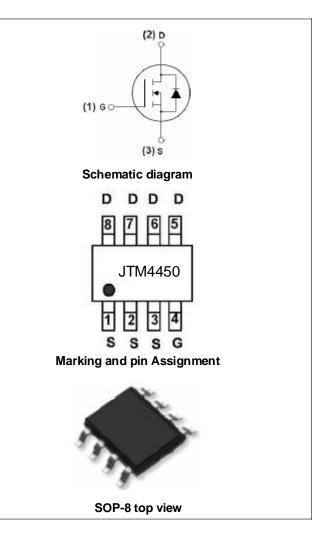
The JTM4450 uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. It can be used in a wide variety of applications.

GENERAL FEATURES

- •Vbs =40V,Ib =7.0A Rbs(on) < 24mΩ @ Vgs=10V Rbs(on) < 38mΩ @ Vgs=4.5V
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply



Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
HM4450	HM4450	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (TA=25 °C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	7	A
Drain Current-Continuous(Ta=100℃)	l⊳ (100℃)	5	A
Pulsed Drain Current	Ідм	30	А
Maximum Power Dissipation	PD	3	W
Operating Junction and Storage Temperature Range	Тյ,Тѕтс	-55 To 150	°C

Thermal Characteristic				
Thermal Resistance, Junction-to-Ambient(Note 2)	Reja	42	°CW	

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Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	Vgs=0V Id=250µA	30	33	-	V
Zero Gate Voltage Drain Current	loss	VDS=30V,VGS=0V	-	-	1	μA
Gate-Body Leakage Current	lgss	Vgs=±20V,Vds=0V	-	-	±100	nA
On Characteristics (Note 3)	· · ·					
Gate Threshold Voltage	VGS(th)	Vos=Vgs,Io=250µA	1	1.3	2.2	V
Drain-Source On-State Resistance	Rds(on)	Vgs=10V, Id=7A	-	18.5	24	mΩ
Drain-Source On-State Resistance		Vgs=4.5V, Id=5A	-	27	38	
Forward Transconductance	g fs	VDS=5V,ID=7A	5	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	Clss	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	2100	-	PF
Output Capacitance	Coss		-	460	-	PF
Reverse Transfer Capacitance	Crss		-	230	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	td(on)		-	20	-	nS
Turn-on Rise Time	tr	VDD=10V,ID=7A	-	15	-	nS
Turn-Off Delay Time	td(off)	Vgs=10V,Rgen=2.7Ω	-	60	-	nS
Turn-Off Fall Time	tr		-	10	-	nS
Total Gate Charge	Qg		-	41	-	nC
Gate-Source Charge	Qgs	VDS=10V,ID=7A,	-	14	-	nC
Gate-Drain Charge	Qgd	Vgs=10V	-	11	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	Vsd	Vgs=0V,Is=7A	-	-	1.2	V
Diode Forward Current (Note 2)	ls		-	-	7	А

Electrical Characteristics (TA=25 $^\circ\! C$ unless otherwise noted)

Notes:

 $\label{eq:constraint} \textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

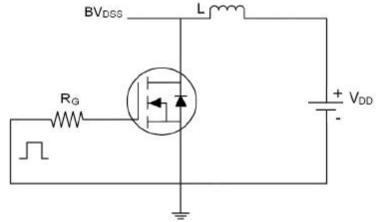
3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

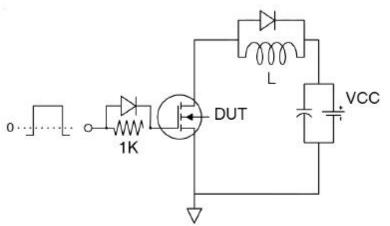
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Test circuit

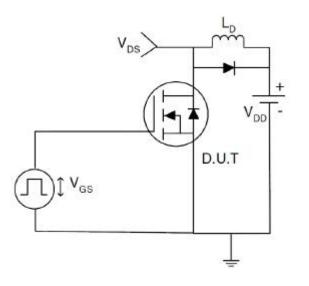
1) Eas test Circuits



2) Gate charge test Circuit:

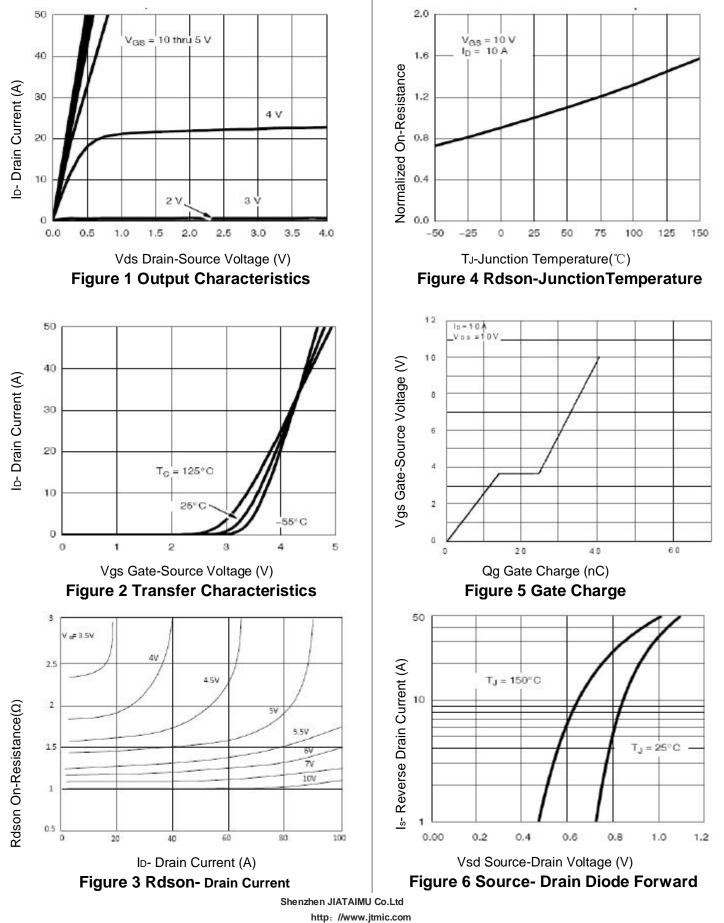


3) Switch Time Test Circuit:

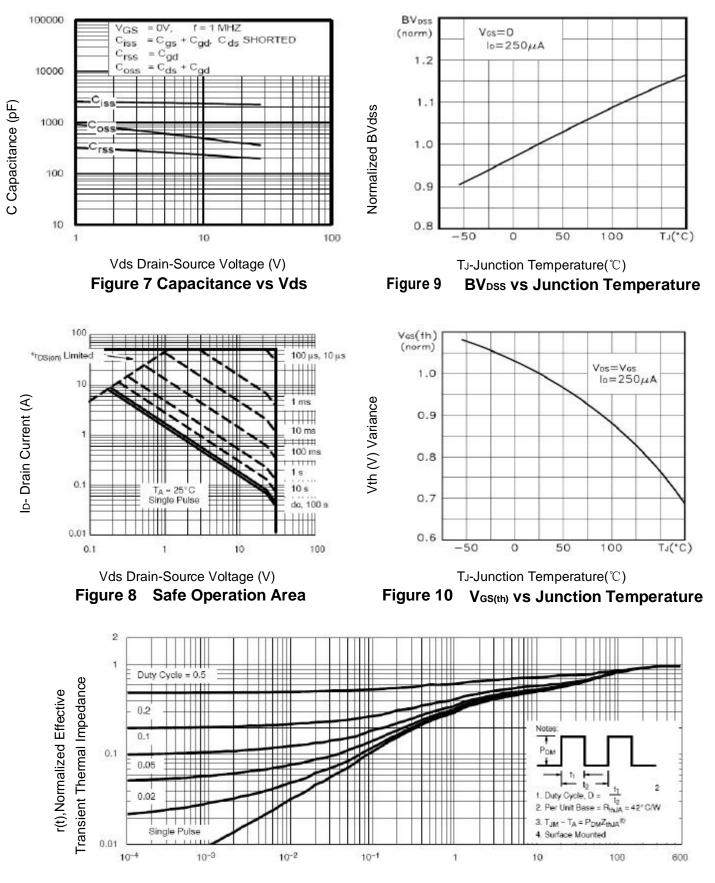


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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)



JTM4450



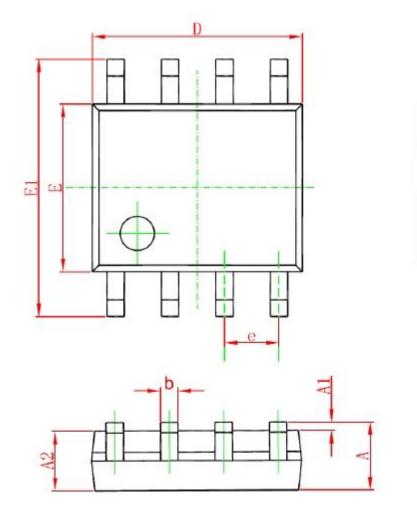
Square Wave Pluse Duration(sec)
Figure 11 Normalized Maximum Transient Thermal Impedance

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SOP-8 PACKAGE IN FORMATION



0 1 1	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0. 250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0. 330	0. 510	0.013	0. 020	
С	0.170	0. 250	0.006	0.010	
D	4. 700	5. 100	0. 185	0.200	
E	3.800	4.000	0.150	0. 157	
E1	5.800	6. 200	0. 228	0. 244	
e	1.27	0 (BSC)	0.050	0 (BSC)	
L	0.400	1. 270	0.016	0. 050	
θ	0°	8°	0°	8°	

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